MURTT30060(A)(R)

SUPER FAST DIODE MODULE TYPE 300A

Features

High Surge Capability
Type 600V V_{RRM}
Isolation Type Package
Electrically Isolation base plate

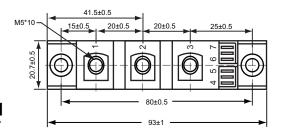
Maximum Ratings

Junction Operating Temperature : -55°C to +175°C Storage Temperature : -55°C to +175°C

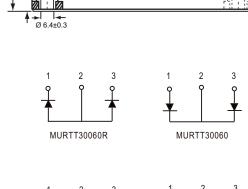
Part Number	Maximum Recurrent Peak Reverse Voltage	Maximum RMS Voltage	Maximum DC Blocking Voltage
MURTT30060(A)(R)	600V	420V	600V

TO-240AA

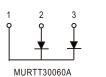
Dimensions in mm (1 mm = 0.0394")



Average Forward Current (Per pkg)	I F(AV)	300A	Tc = 125°C
Peak Forward Surge Current (Per diode)	IFSM	2750A	8.3ms , half sine
Maximum (Per diode) Instantaneous Forward Voltage *	VF	1.5V	IFM=150A;ТJ = 25°С
Maximum Instantaneous Reverse Current At Rated DC Blockig Voltage* (Per diode)	lr	25µA 3mA	T _J = 25°C T _J = 125°C
Maximum Reverse Recovery Tlme (Per diode)	Trr	105ns	IF = 0.5A,IR = 1.0A IRR = 0.25A
Isolation Voltage	Viso	2500V	A.C. 1 minute
Maximum Thermal Resistance Junction To Case (Per diode)	Røjc	0.40°C/W	
Mounting torque		4 ± 0.5Nm 3 ± 0.5Nm	



NAME PLATE

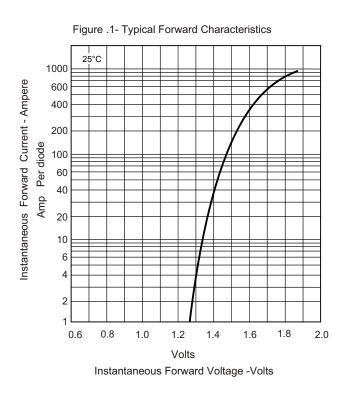


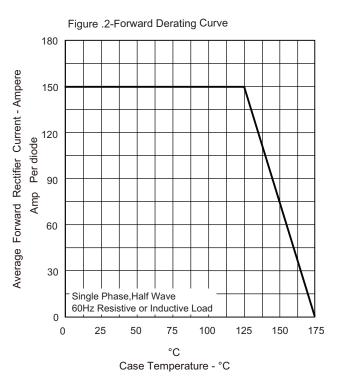


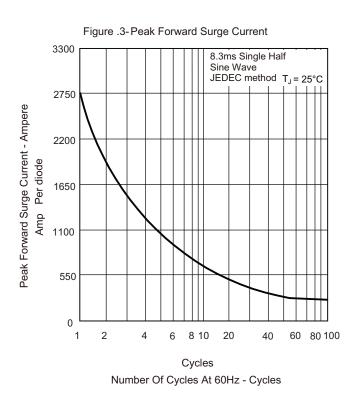
^{*}Pulse Test: Pulse Width 300 μ sec, Duty Cycle < 2%

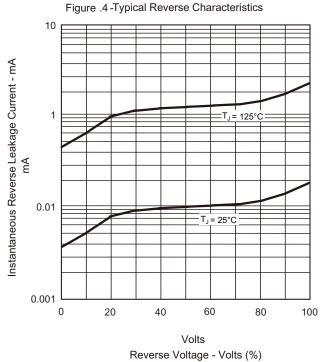


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